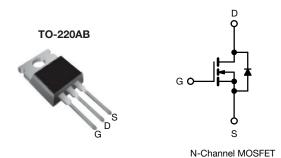
Vishay Siliconix

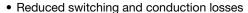
## **E Series Power MOSFET**



PRODUCT SUMMARY					
$V_{DS}$ (V) at $T_J$ max.	650				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.158				
Q <sub>g</sub> max. (nC)	95				
Q <sub>gs</sub> (nC)	16				
Q <sub>gd</sub> (nC)	25				
Configuration	Single				

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>



#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Load (Dh) free and balagen free	SiHP23N60E-BE3			
Lead (Pb)-free and halogen-free	SiHP23N60E-GE3			

ABSOLUTE MAXIMUM RATINGS (To	; = 25 °C, un	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	600		
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain augrent /T 150 °C)	V -140 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I <sub>D</sub>	23	А	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		15		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	63		
Linear derating factor				1.8	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	353	mJ	
Maximum power dissipation			P <sub>D</sub>	227	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$T_{J} = 1$	T <sub>J</sub> = 125 °C		37	)//	
Reverse diode dV/dt <sup>d</sup>			dV/dt	34	- V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	For	For 10 s		300	°C	

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 5 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ ,  $dI/dt = 100 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \,^{\circ}\text{C}$



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THERMAL RESISTACNE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W		
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.55			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•			
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.72	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
Cata agura laglaga	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage		1	V <sub>GS</sub> = ± 30 V		-	± 1	μA
Zama anta malta an dunin annuant		V <sub>DS</sub> =	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 480 \text{ V}$	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 12 A	-	0.132	0.158	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	= 30 V, I <sub>D</sub> = 12 A	-	6.4	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1  MHz		2418	-	
Output capacitance	C <sub>oss</sub>	١ ,			119	-	
Reverse transfer capacitance	C <sub>rss</sub>	7			4	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	107	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	320	-	
Total gate charge	Qg			-	63	95	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V		16	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	25	-	
Turn-on delay time	t <sub>d(on)</sub>			-	22	44	
Rise time	t <sub>r</sub>	$V_{DD} = 480 \text{ V}, I_{D} = 12 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	38	76	ns
Turn-off delay time	t <sub>d(off)</sub>			_	66	99	
Fall time	t <sub>f</sub>			_	34	68	
Gate input resistance	$R_g$	f = 1 MHz, open drain		-	0.73	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	
Pulsed diode forward current	I <sub>SM</sub>			-	-	63	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 12 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V
Reverse recovery time	t <sub>rr</sub>	10 == 2,10 1=1,100 0		-	384	768	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_{\rm J} = 25$	5 °C, I <sub>F</sub> = I <sub>S</sub> = 12 A,	-	6.4	12.8	μC
Reverse recovery current	I <sub>RRM</sub>	$dI/dt = 100 \text{ A/}\mu\text{s}, \text{ V}_{R} = 25 \text{ V}$		_	30	_	Α

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

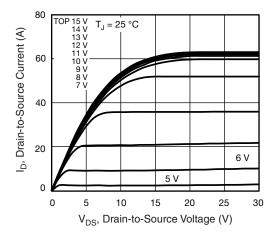


Fig. 1 - Typical Output Characteristics

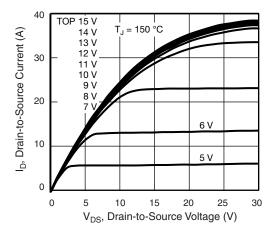


Fig. 2 - Typical Output Characteristics

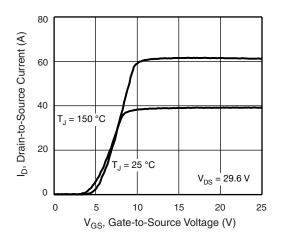


Fig. 3 - Typical Transfer Characteristics

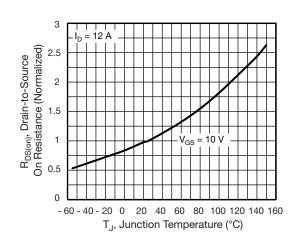


Fig. 4 - Normalized On-Resistance vs. Temperature

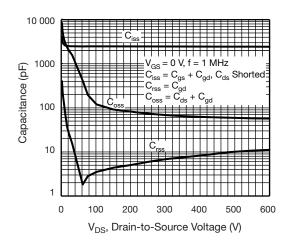


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

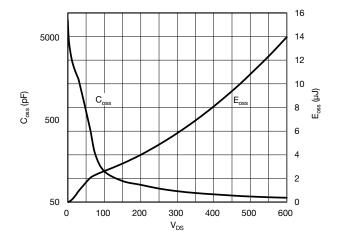


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $\mbox{V}_{DS}$ 



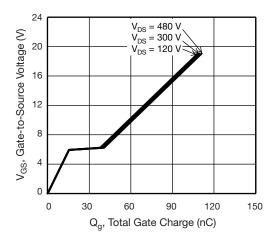


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

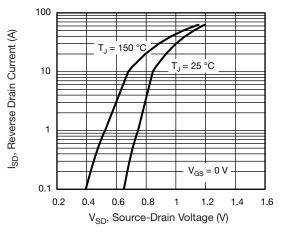


Fig. 8 - Typical Source-Drain Diode Forward Voltage

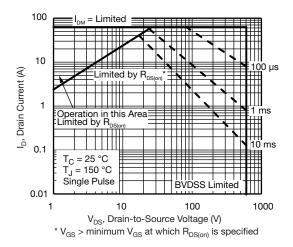


Fig. 9 - Maximum Safe Operating Area

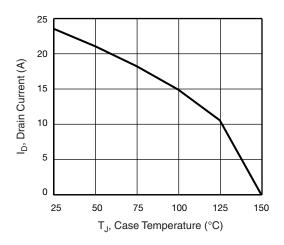


Fig. 10 - Maximum Drain Current vs. Case Temperature

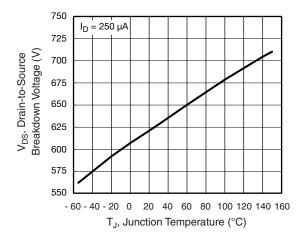


Fig. 11 - Temperature vs. Drain-to-Source Voltage



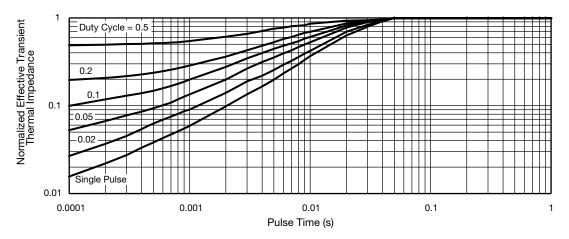


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

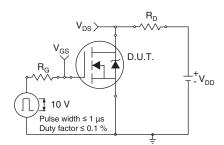


Fig. 13 - Switching Time Test Circuit

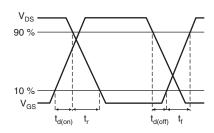


Fig. 14 - Switching Time Waveforms

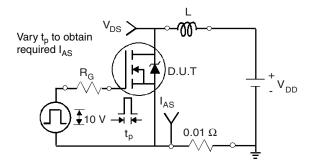


Fig. 15 - Unclamped Inductive Test Circuit

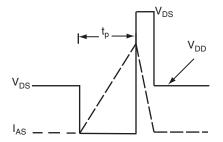


Fig. 16 - Unclamped Inductive Waveforms

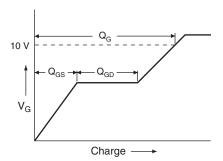


Fig. 17 - Basic Gate Charge Waveform

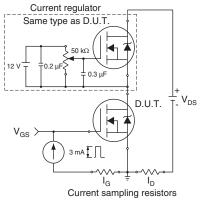
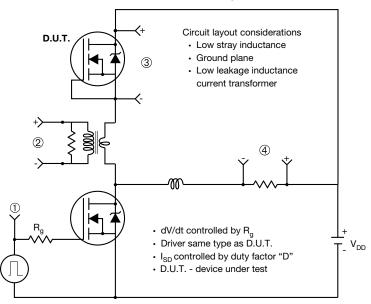


Fig. 18 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



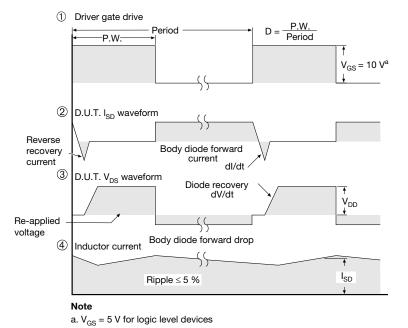
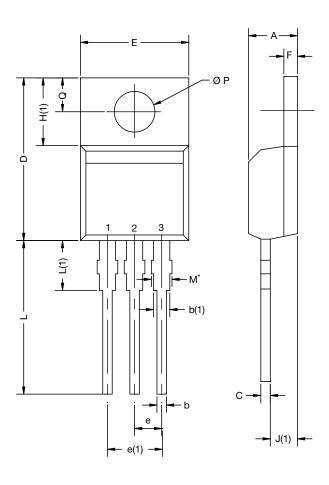


Fig. 19 - For N-Channel

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# TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

### Note

•  $M^* = 0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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